



BAV99

Features

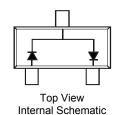
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound (Note 2). UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)



Top View



Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
BAV99-7-F	Standard	SOT23	3,000/Tape & Reel
BAV99-13-F	Standard	SOT23	10,000/Tape & Reel
BAV99Q-7-F	Automotive	SOT23	3,000/Tape & Reel
BAV99Q-13-F	Automotive	SOT23	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

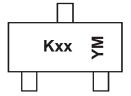
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

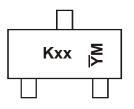
4. Product manufactured with Date Code 9W (week 39, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 9W are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



xx = Product Type Marking Code
YM = Date Code Marking for Shanghai Assembly / Test site
Y = Year (ex: A = 2013)
M = Month (ex: 9 = September)



 $\begin{array}{l} xx = \mbox{Product Type Marking Code} \\ \overline{Y}M = \mbox{Date Code Marking for Chengdu} \\ Assembly / Test site \\ \overline{Y} = \mbox{Year (ex: A = 2013)} \\ M = \mbox{Month (ex: 9 = September)} \end{array}$

Date Code Key

Year	1998	1999		2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	J	K		Т	U	V	W	Х	Y	Z	Α	В	С	D	E
Month	Jan	Fel)	Mar	Apr	Мау	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage	V _{R(RMS)}	53	V
Forward Continuous Current (Note 6)	I _{FM}	300	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0ps	I _{FSM}	2.0 1.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 6)	PD	350	mW	
Thermal Resistance Junction to Ambient Air (Note 6)	R _{0JA}	357	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C	

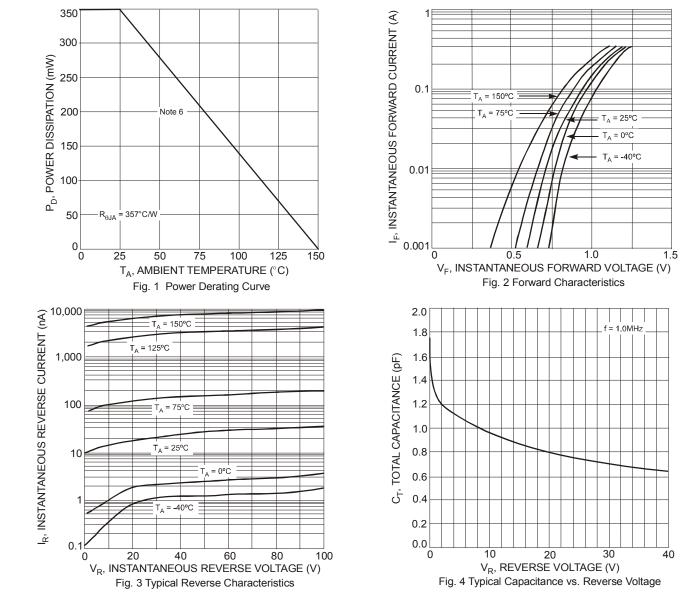
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	75	_	V	I _R = 2.5μA
Forward Voltage	VF		0.715 0.855 1.0 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 7)	I _R	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$, $T_J = +150^{\circ}C$ $V_R = 25V$, $T_J = +150^{\circ}C$ $V_R = 20V$
Total Capacitance	CT	_	2.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}		4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

 Part mounted on Polymide PC board with pad dimensions 1.13mm x 1.27mm.
 Short duration pulse test used to minimize self-heating effect. Notes:

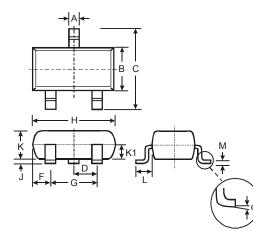






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

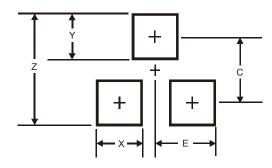


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
ĸ	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
М	0.085	0.18	0.11				
α	0°	8°	-				
All	All Dimensions in mm						



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Z	2.9		
Х	0.8		
Y	0.9		
С	2.0		
E	1.35		

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